



SD3931-10

RF power transistors HF/VHF/UHF N-channel MOSFETs

Features

- Excellent thermal stability
- Common source configuration
- $P_{OUT} = 175\text{ W}$ min. with 23 dB gain @ 150 MHz
- In compliance with the 2002/95/EC European directive

Description

The SD3931-10 is an N-channel MOS field-effect RF power transistor. It is intended for use in 100 V DC large signal applications up to 150 MHz.

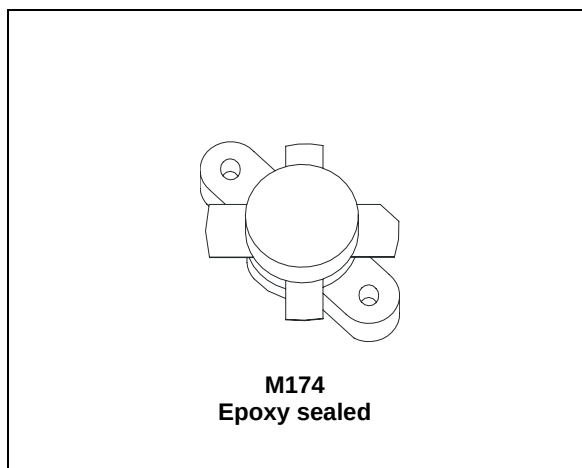


Figure 1. Pin connection

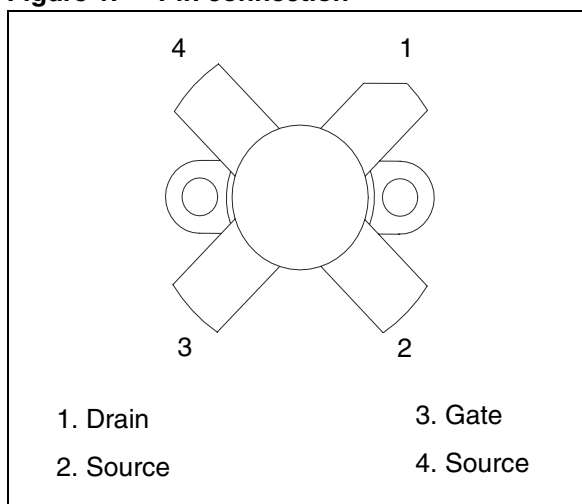


Table 1. Device summary

Order code	Marking	Package	Packaging
SD3931-10	SD3931-10	M174	Plastic tray

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1 Electrical data

1.1 Maximum ratings

Table 2. Absolute maximum ratings ($T_{CASE} = 25^{\circ}C$)

Symbol	Parameter	Value	Unit
$V_{(BR)DSS}^{(1)}$	Drain source voltage	250	V
V_{DGR}	Drain-gate voltage ($R_{GS} = 1M\Omega$)	250	V
V_{GS}	Gate-source voltage	± 20	V
I_D	Drain current	10	A
P_{DISS}	Power dissipation	389	W
T_J	Max. operating junction temperature	200	$^{\circ}C$
T_{STG}	Storage temperature	-65 to +150	$^{\circ}C$

1. $T_J = 150^{\circ}C$

1.2 Thermal data

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Junction - case thermal resistance	0.45	$^{\circ}C/W$

2 Electrical characteristics

$$T_{\text{CASE}} = +25\text{ }^{\circ}\text{C}$$

2.1 Static

Table 4. Static (per side)

Symbol	Test conditions		Min	Typ	Max	Unit
$V_{(\text{BR})\text{DSS}}^{(1)}$	$V_{\text{GS}} = 0\text{ V}$	$I_{\text{DS}} = 100\text{ mA}$	250			V
I_{DSS}	$V_{\text{GS}} = 0\text{ V}$	$V_{\text{DS}} = 100\text{ V}$			1	mA
I_{GSS}	$V_{\text{GS}} = 20\text{ V}$	$V_{\text{DS}} = 0\text{ V}$			250	nA
$V_{\text{GS(Q)}}$	$V_{\text{DS}} = 10\text{ V}$	$I_{\text{D}} = 250\text{ mA}$	1.5	2.5	4.0	V
$V_{\text{DS(ON)}}$	$V_{\text{GS}} = 10\text{ V}$	$I_{\text{D}} = 5\text{ A}$		2.5	3.5	V
G_{FS}	$V_{\text{DS}} = 10\text{ V}$	$I_{\text{D}} = 2.5\text{ A}$	2.5			S
C_{ISS}	$V_{\text{GS}} = 0\text{ V}$	$V_{\text{DS}} = 100\text{ V}$		500		pF
C_{OSS}	$V_{\text{GS}} = 0\text{ V}$	$V_{\text{DS}} = 100\text{ V}$		134		pF
C_{RSS}	$V_{\text{GS}} = 0\text{ V}$	$V_{\text{DS}} = 100\text{ V}$		6		pF

1. $T_{\text{J}} = 150^{\circ}\text{C}$

2.2 Dynamic

Table 5. Dynamic

Symbol	Test conditions	Min	Typ	Max	Unit
$P_{1\text{dB}}$	$V_{\text{DD}} = 100\text{ V}$ $I_{\text{DQ}} = 250\text{ mA}$ $f = 150\text{ MHz}$	175	230		W
G_{PS}	$V_{\text{DD}} = 100\text{ V}$ $I_{\text{DQ}} = 250\text{ mA}$ $P_{\text{OUT}} = 175\text{ W}$ $f = 150\text{ MHz}$	20	21.3		dB
η_{D}	$V_{\text{DD}} = 100\text{ V}$ $I_{\text{DQ}} = 250\text{ mA}$ $P_{\text{OUT}} = 175\text{ W}$ $f = 150\text{ MHz}$	50	57		%
Load mismatch	$V_{\text{DD}} = 100\text{ V}$ $I_{\text{DQ}} = 250\text{ mA}$ $P_{\text{OUT}} = 150\text{ W}$ $f = 150\text{ MHz}$ All phase angles	3:1			VSWR

3 Impedance data

Figure 2. Impedance data

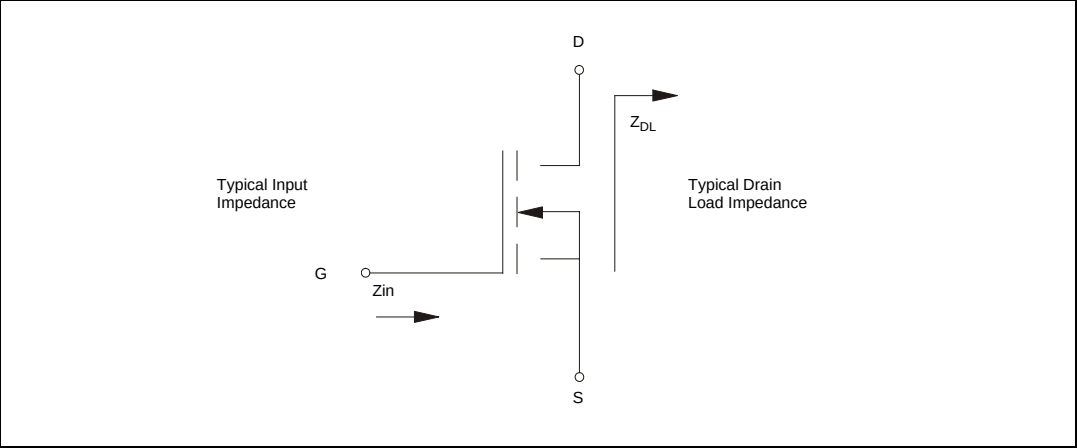


Table 6. Impedance data

Freq	$Z_{IN} (\Omega)$	$Z_{DL} (\Omega)$
150 MHz	$0.42 - j\ 3.1$	$3.4 + j\ 5.5$

4 Typical performance

Figure 3. Capacitances vs voltage

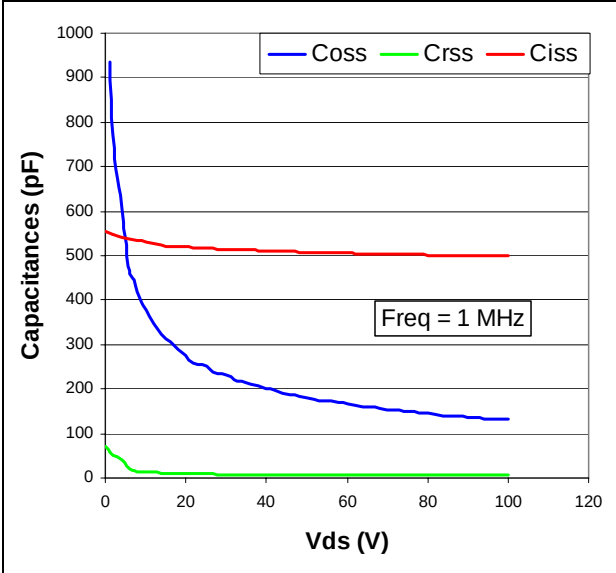


Figure 4. Gain vs output power and bias current

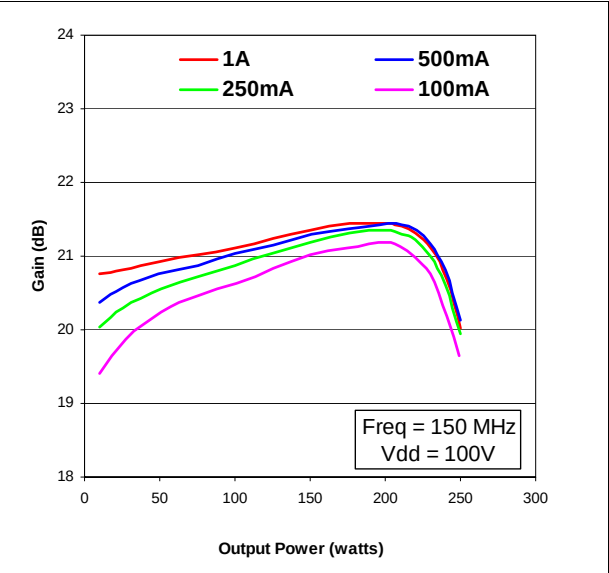


Figure 5. Output power and efficiency vs input power

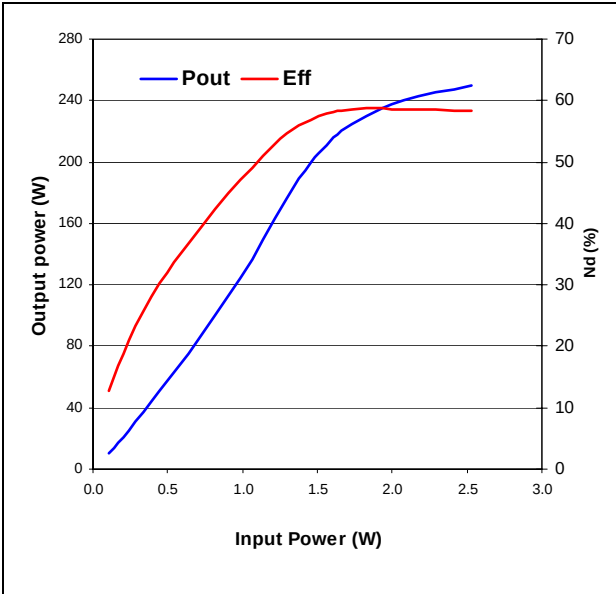


Figure 6. Zero temperature coefficient point

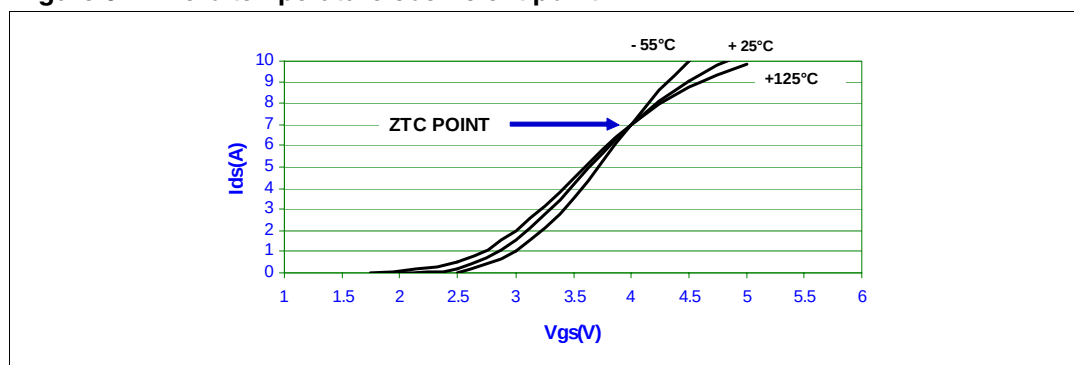
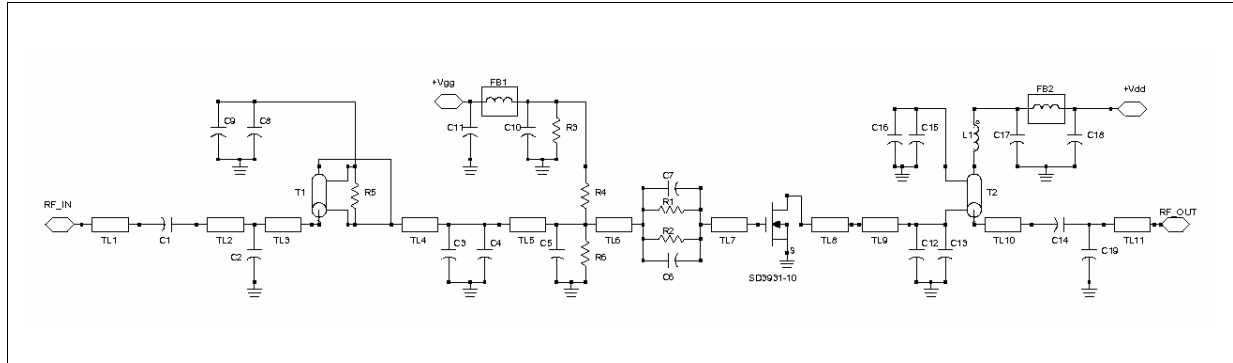


Table 7. Vgs sort (@250 mA)

Marking	Min	Max
DD	1.5	1.6
EE	1.6	1.7
FF	1.7	1.8
A	1.8	1.9
B	1.9	2
C	2	2.1
D	2.1	2.2
E	2.2	2.3
F	2.3	2.4
G	2.4	2.5
H	2.5	2.6
I	2.6	2.7
J	2.7	2.8
K	2.8	2.9
L	2.9	3
M	3	3.1
N	3.1	3.2
O	3.2	3.3
P	3.3	3.4
Q	3.4	3.5
R	3.5	3.6
S	3.6	3.7
T	3.7	3.8
U	3.8	3.9
V	3.9	4

Figure 7. Test circuit



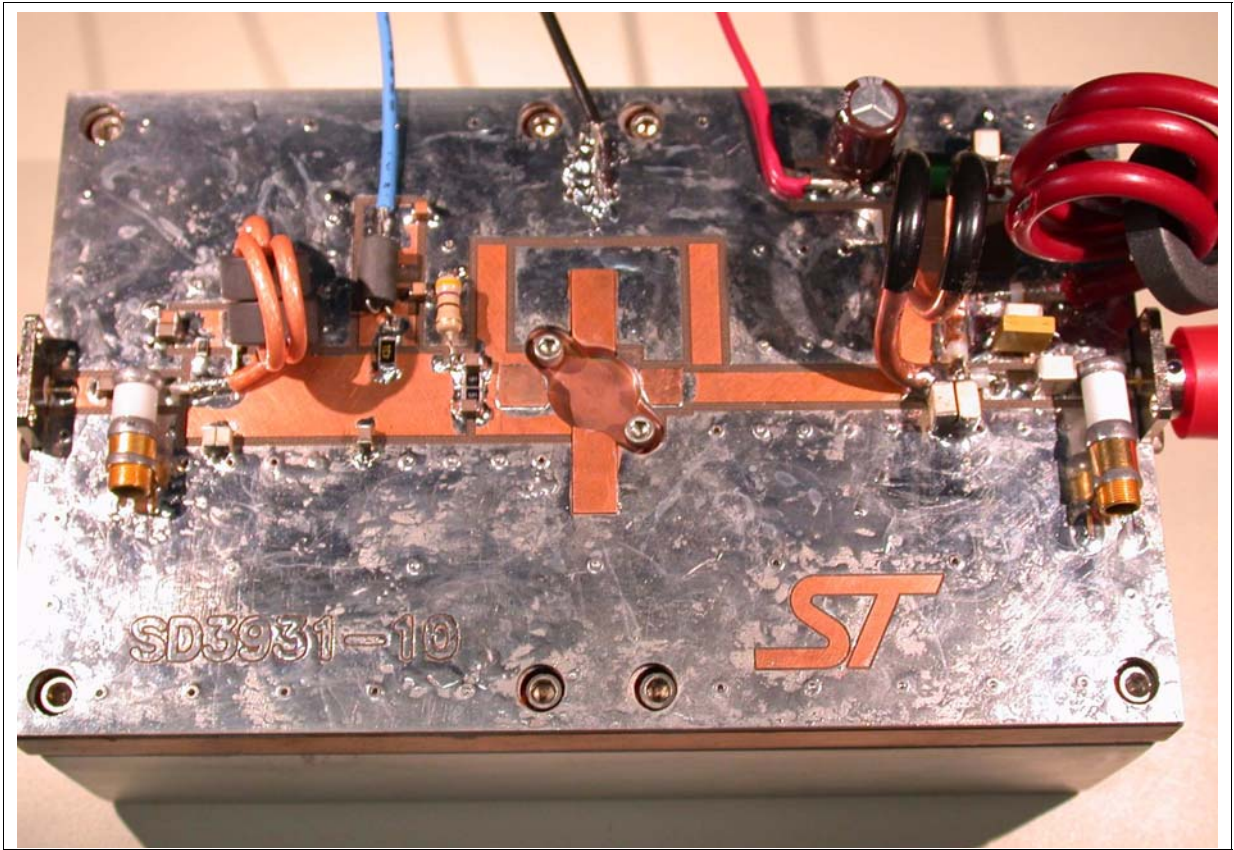
Component	Description
C1, C8	1200 pF ATC 700B chip capacitor
C2	1-20 Johanson air variable capacitor
C3, C4	120 pF ATC 100B chip capacitor
C5	300 pF ATC 100B chip capacitor
C6, C7	470 pF ATC 100B chip capacitor
C9, C10, C11	10,000 pF ATC 200B chip capacitor
C12, C16	470 pF ATC 100C chip capacitor
C13	120 pF ATC 100C chip capacitor
C14, C17	1,000 pF ATC 100C chip capacitor
C15	0.1 uF molded ceramic capacitor
C18	10 uF, 200 V electrolytic capacitor
C19	1-30 pF Johanson variable capacitor
R1, R2	5.1 Ω , 1/4 W chip resistor
R3	470 Ω , 1/8 W chip resistor
R4	430 Ω , 1/2 W chip resistor
R5	360 Ω , 1/8 W chip resistor
R6	470 ohm, 1/2 W carbon axial lead resistor
FB1, FB2	ferrite bead, VK200
L1	RG-141, 13.6" thru Fair-Rite toroid #2643801502, 3 turns
TI	4:1 transformer, 25 Ω coaxial cable, 6", thru 2 x Fair-Rite toroid # 5943001101, 2 turns
T2	1:4 transformer, 25 ohm semi-rigid coaxial cable, OD .141", 6", 2 turns
TL1	0.340" x 0.175" microstrip

Table 8. Bill of materials (continued)

Component	Description
TL2	0.135" x 0.175" microstrip
TL3	0.225" x 0.175" microstrip
TL4	0.175" x 0.500" microstrip
TL5	0.805" x 0.500" microstrip
TL6	0.600" x 0.500" microstrip
TL7	0.420" x 0.500" microstrip
TL8	0.265" x 0.240" microstrip
TL9	1.550" x 0.180" microstrip
TL10	0.360" x 0.175" microstrip
TL11	0.300" x 0.175" microstrip
PCB	0.062" woven glass, copper clad, Er = 2.55

6 **Circuit layout**

Figure 8. Circuit layout photo

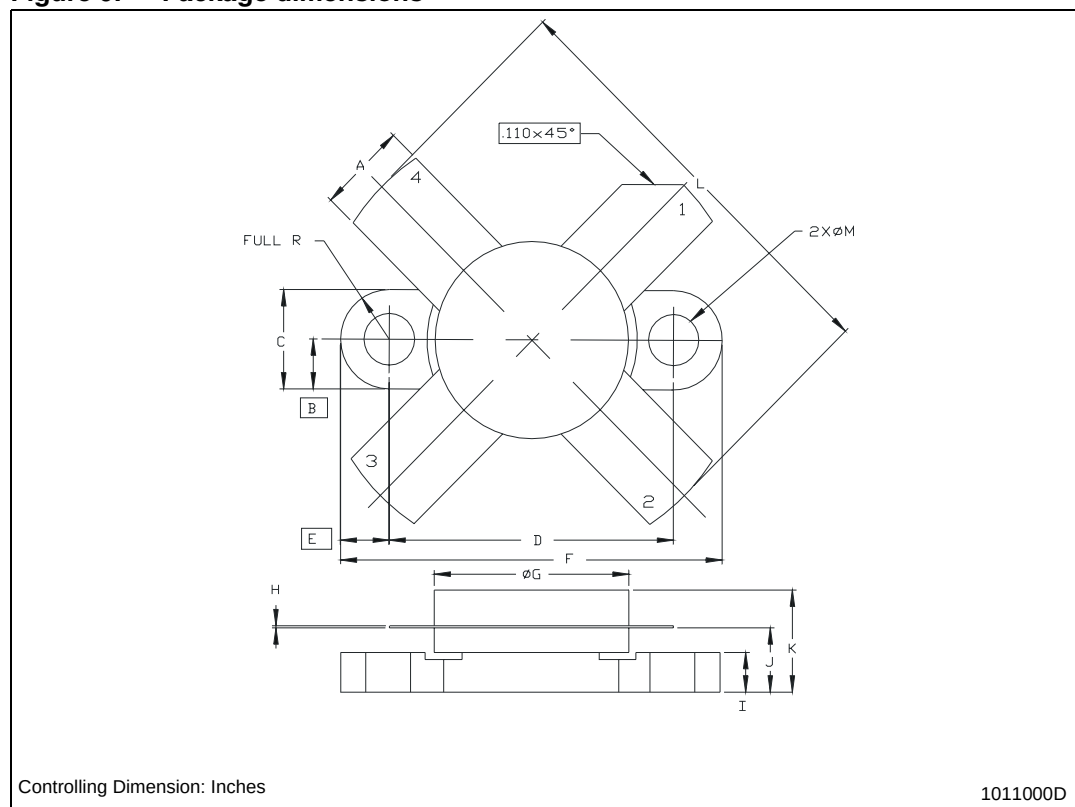


7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. E
COPACK[®] specifications, grade definitions and product status are available at: www.st.com.
ECOPACK is an ST trademark.

Table 9. M174 (0.500 DIA 4/L N/HERM W/FLG) mechanical data

Dim.	mm.			Inch		
	Min	Typ	Max	Min	Typ	Max
A	5.56		5.584	0.219		0.230
B		3.18			0.125	
C	6.22		6.48	0.245		0.255
D	18.28		18.54	0.720		0.730
E		3.18			0.125	
F	24.64		24.89	0.970		0.980
G	12.57		12.83	0.495		0.505
H	0.08		0.18	0.003		0.007
I	2.11		3.00	0.083		0.118
J	3.81		4.45	0.150		0.175
K			7.11			0.280
L	25.53		26.67	1.005		1.050
M	3.05		3.30	0.120		0.130

Figure 9. Package dimensions

8 Revision history

Table 10. Document revision history

Date	Revision	Changes
15-Jun-2007	1	First release
11-Jul-2007	2	Inserted Table 7: Vgs sort (@250 mA) on page 7
26-Oct-2007	3	Updated Table 4: Static (per side) on page 4 Added Section 5: Test circuit on page 8 , Section 6: Circuit layout on page 9
11-Jul-2008	4	Updated Table 4: Static (per side) on page 4
07-Sep-2010	5	Updated features on cover page.

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